

DDODITCT/DDOCESS CHANCE NOTICE (DCN)

PRODUC	1/PROCESS C	HANGE NUTICE (PCN)				
PCN #: SR0003-02 Product Affected: 71V016S, 71V124S, Manufacturing Location Affected:	DATE: 5/3/00 71V016SA, 71V124SA N/A	MEANS OF DISTINGUISHING CHANGED DEVICES: ■ Product Mark "H" character on top mark □ Back Mark □ Date Code				
Date Effective: 8/3/00		□ Other				
Contact: Mary Vesey Title: Director of Quality Phone #: (831)-754-4565 Fax #: (831)-754-4672 E-mail: Mary.vesey@idt.com		Attachment:: Yes No Samples: Available on request				
DESCRIPTION AND DURINGSE OF	CHANCE.					
DESCRIPTION AND PURPOSE OF □ Die Technology □ Wafer Fabrication Process □ Assembly Process □ Equipment □ Material □ Testing □ Manufacturing Site □ Data Sheet □ Other		From "K" Die revision to "H".				
RELIABILITY/QUALIFICATION SUMMARY: Qualification is expected to be completed 6/15/00 and will be available upon request.						
CUSTOMER ACKNOWLEDGMENT OF RECEIPT: IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.						
Customer:		Approval for shipments prior to effective date.				
Name/Date:	E-	Mail Address:				
Title:	Ph	none# /Fax# :				
CUSTOMER COMMENTS:						
IDT ACKNOWLEDGMENT OF RE	CCEIPT:					
RECD. BY:		DATE:				

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ATTACHMENT - PCN #: SR0003-02

PCN Summary

PCN Type: Mask/Design Change for Die Shrink

Commodity Memory

Forecast or Execute Execute

Planned or Unplanned Planned

Data Sheet Change No

Detail of Change Die Revision K Step H Step

Wafer Fab Facility	Hillsboro, OR	Hillsboro, OR	
Wafer Fab Technology	Cmos 11.5	Cmos 11.5	
Wafer Size	8 inch	8 inch	
Cell Type	6T	6T	
# Poly Layers	1	1	
# Metal Layers	3	3	
Die Dimension (sq mils)	28.3k	15.3k	

Conversion schedule (Estimated)

	Sample Availability	Production Shipments
71V016S	6/1/00	7/24/00
71V0103 71V124S	6/1/00	7/24/00
71V016SA	6/15/00	7/24/00
71V124SA	6/15/00	7/24/00



Integrated Device Technology, Inc. 2975 Stender Way, Santa Clara, CA - 95054

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Qualification Plan QS 9811-12

Test Vehicle: 71V016S Expected Completion Date: 6/15/00 7/15/00

_		6/15/00	7/15/00
	Lot SS / Acc #	Lot # 1	Lot # 2
Dynamic Life Test: 750 hours @ +135°C, 4Vcc	116 / 0		
High Temp Storage Test: 1000 hours @ +150°C	77 / 0		
Temperature Cycle: -65°C to +150°C, 1000	45 / 0		
HAST: 100 hours @ +130°C/85% R.H. 100	45 / 0		
Autoclave: Unbiased 2 ATM Saturated Steam @	45 / 0		
ESD: Human Body Model	12 / 0		
ESD: Charged Device Model	12 / 0		
Latch-Up Immunity	6/0		
Bake & Ballshear Test: +200°C - 48 hour	20 / 0		

Characterization Data: Characterization will be completed as part of product qualification

and data available upon request.